International Rectifier

- Advanced Process Technology
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Lead-Free

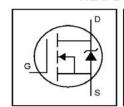
Description

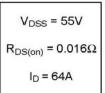
Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

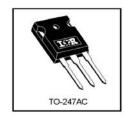
The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because of its isolated mounting hole.

IRFP048NPbF

HEXFET® Power MOSFET







Absolute Maximum Ratings

	Parameter	Max.	Units	
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V	64		
I _D @ T _C = 100°C Continuous Drain Current, V _{GS} @ 10V		45	Α	
I _{DM}	Pulsed Drain Current ①⑤	210		
P _D @T _C = 25°C	Power Dissipation	140	W	
	Linear Derating Factor	0.90	W/°C	
V _{GS}	Gate-to-Source Voltage	± 20	V	
E _{AS}	Single Pulse Avalanche Energy 25	270	mJ	
l _{AR}	Avalanche Current®®	32	Α	
E _{AR}	Repetitive Avalanche Energy①	14	mJ	
dv/dt	Peak Diode Recovery dv/dt 35	5.0	V/ns	
TJ	Operating Junction and	-55 to + 175		
T _{STG}	Storage Temperature Range		°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		
	Mounting torque, 6-32 or M3 srew	10 lbf•in (1.1N•m)		

Thermal Resistance

	Parameter	Тур.	Max.	Units
Reuc	Junction-to-Case		1.1	
R _{OCS}	Case-to-Sink, Flat, Greased Surface	0.24		°C/W
ReJA	Junction-to-Ambient		40	

International **TOR** Rectifier

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	55			٧	$V_{GS} = 0V, I_D = 250\mu A$
ΔV(BR)DSS/ΔTJ	Breakdown Voltage Temp. Coefficient		0.052		V/°C	Reference to 25°C, I _D = 1mA ^⑤
R _{DS(on)}	Static Drain-to-Source On-Resistance	-		0.016	Ω	V _{GS} = 10V, I _D = 37A ④
V _{GS(th)}	Gate Threshold Voltage	2.0		4.0	٧	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
g fs	Forward Transconductance	22	-	-	S	V _{DS} = 25V, I _D = 32A ^⑤
1	Droin to Source Leekoge Current			25	μΑ	$V_{DS} = 55V, V_{GS} = 0V$
I _{DSS}	Drain-to-Source Leakage Current			250	μΑ	$V_{DS} = 44V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
1	Gate-to-Source Forward Leakage			100	nA	V _{GS} = 20V
I _{GSS}	Gate-to-Source Reverse Leakage		1270	-100	nA ·	V _{GS} = -20V
Qg	Total Gate Charge			89		I _D = 32A
Qgs	Gate-to-Source Charge			20	nC	V _{DS} = 44V
Q _{gd}	Gate-to-Drain ("Miller") Charge			39		V _{GS} = 10V, See Fig. 6 and 13 ⊕ ⑤
t _{d(on)}	Turn-On Delay Time		11			V _{DD} = 28V
tr	Rise Time		78		F42000	I _D = 32A
t _{d(off)}	Turn-Off Delay Time		32		ns	$R_{G} = 5.1\Omega$
t _f	Fall Time		48			R _D = 0.85Ω, See Fig. 10 ⊕⑤
L _D	Internal Drain Inductance		5.0			Between lead, 6mm (0.25in.)
L _S	Internal Source Inductance	_	13	_	nΗ	from package and center of die contact
Ciss	Input Capacitance		1900			V _{GS} = 0V
Coss	Output Capacitance		620		pF	V _{DS} = 25V
C _{rss}	Reverse Transfer Capacitance		270			f = 1.0MHz, See Fig. 5®

Source-Drain Ratings and Characteristics

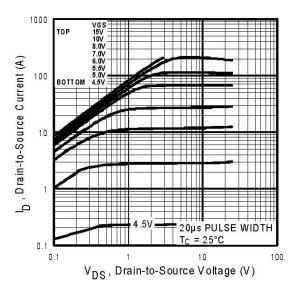
	Parameter	Min.	Тур.	Мах.	Units	Conditions
Is	Continuous Source Current			45		MOSFET symbol
	(Body Diode)			– 45		showing the
I _{SM}	Pulsed Source Current			210	210 A	integral reverse
	(Body Diode) ①⑤		210	0	p-n junction diode.	
V_{SD}	Diode Forward Voltage		_	1.3	٧	$T_J = 25$ °C, $I_S = 37A$, $V_{GS} = 0V$ ④
trr	Reverse Recovery Time		94	140	ns	T _J = 25°C, I _F = 32A
Qm	Reverse RecoveryCharge	(<u> </u>	360	540	nC	di/dt = 100A/µs ⊕⑤

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- $\begin{tabular}{ll} \mathbb{Q} V_{DD} = 25V, starting T_J = 25°C, L = 530$ μH $$R_G$ = 25$ Ω, I_{AS} = 32$ A. (See Figure 12) \end{tabular}$
- $\label{eq:loss_def} \begin{tabular}{ll} $ I_{SD} \leq 32A, \ di/dt \leq 250A/\mu s, \ V_{DD} \leq V_{(BR)DSS}, \\ $ T_{J} \leq 175^{\circ}C $ \end{tabular}$
- 4 Pulse width $\leq 300 \mu s$; duty cycle $\leq 2\%$.
- ⑤ Uses IRFZ48N data and test conditions

International TOR Rectifier

IRFP048NPbF



BOTTOM 4.5V

BOTTOM 4.5V

20 µs PULSE WIDTH

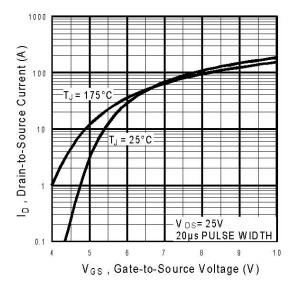
T_C = 175°C

V_{DS}, Drain-to-Source Voltage (V)

1000

Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics



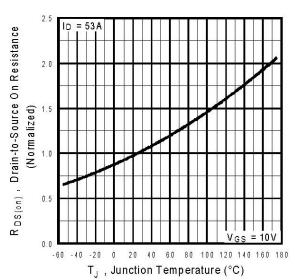


Fig 3. Typical Transfer Characteristics

Fig 4. Normalized On-Resistance Vs. Temperature

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TOR Rectifier

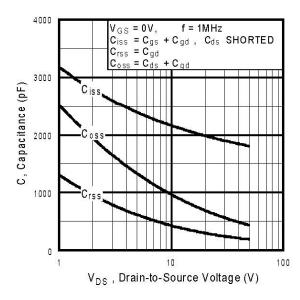


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

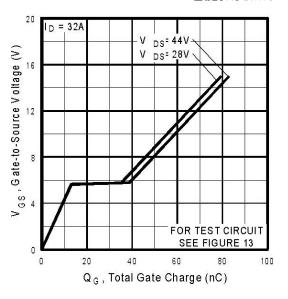


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

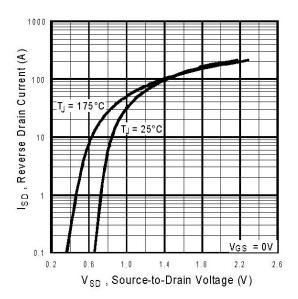


Fig 7. Typical Source-Drain Diode Forward Voltage

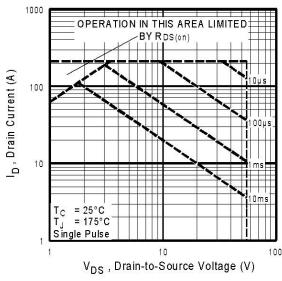


Fig 8. Maximum Safe Operating Area

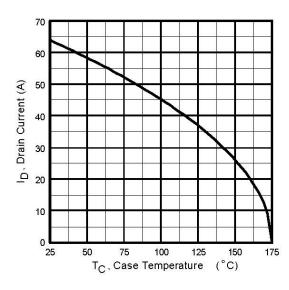


Fig 9. Maximum Drain Current Vs. Case Temperature

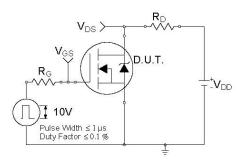


Fig 10a. Switching Time Test Circuit

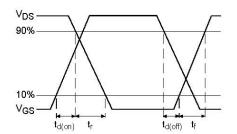


Fig 10b. Switching Time Waveforms

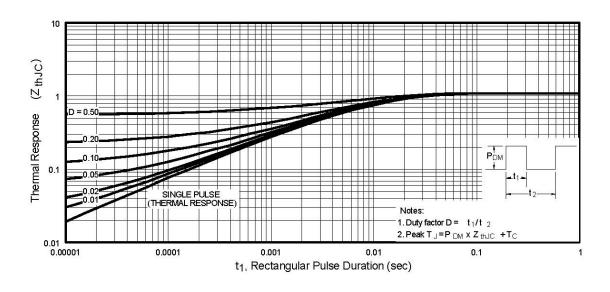


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

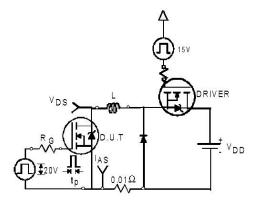


Fig 12a. Unclamped Inductive Test Circuit

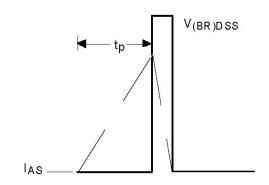


Fig 12b. Unclamped Inductive Waveforms

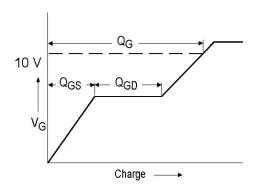


Fig 13a. Basic Gate Charge Waveform

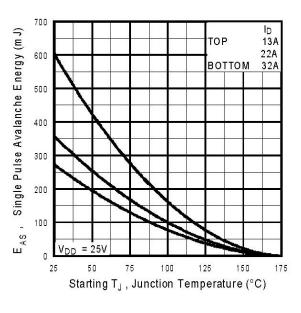


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

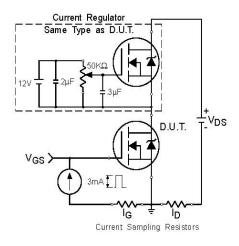
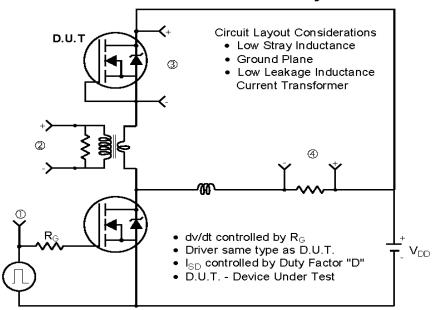


Fig 13b. Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



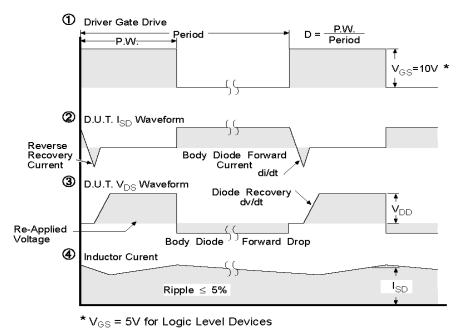
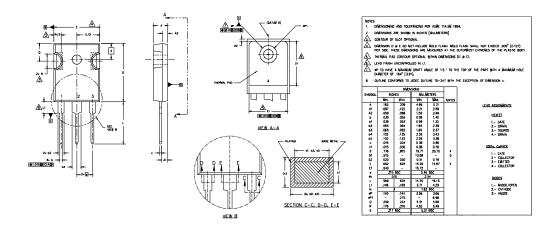


Fig 14. For N-Channel HEXFETS

International
Rectifier

TO-247AC Package Outline

Dimensions are shown in millimeters (inches)



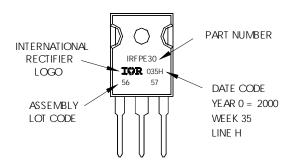
TO-247AC Part Marking Information

EXAMPLE: THIS IS AN IRFPE30

WITH ASSEMBLY LOT CODE 5657

ASSEMBLED ON WW 35, 2000 IN THE ASSEMBLY LINE "H"

Note: "P" in assembly line position indicates "Lead-Free"



Data and specifications subject to change without notice.



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Note: For the most current drawings please refer to the IR website at: http://www.irf.com/package/

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